

# NC4650ZA500D-EV

## Ultra-Low Quiescent Current ( $I_q = 70\text{nA}$ ) Boost Switching Regulator with Low Ripple Mode

### FEATURES

- Operating Junction Temperature Range:  
-40 °C to 125 °C
- Input Voltage Range (Maximum Rating):  
0.6 V to 5.5 V (6.5 V)
- Startup Voltage:  
Typ. 0.8 V
- Output Voltage Range: 1.8 V to 5.0 V (Int. Fixed)
- Quiescent Current ( $V_{OUT}$ ):  
Normal Mode: Typ. 70 nA  
Low Ripple Mode: Typ. 90  $\mu\text{A}$
- Shutdown Current:  
Typ. 50 nA
- Efficiency ( $V_{IN}=1.5\text{ V}$ ,  $V_{OUT}=3.3\text{ V}$ ,  $I_{OUT}=10\text{ }\mu\text{A}$ ):  
Typ. 85 %
- Switch Current Limit:  
Typ. 1 A ( $V_{SET} \geq 2.5\text{ V}$ )  
Typ. 0.65 A ( $V_{SET} < 2.5\text{ V}$ )
- Thermal Shutdown Function:  
Detection Temperature: Typ. 150 °C  
Release Temperature: Typ. 100 °C
- Soft Start Function
- Buck Operation or Pass-Through when  
 $V_{IN} > V_{OUT}$
- Manual switching between Normal Mode and Low Ripple Mode via MODE Pin
- Multiple versions for shutdown behavior

### APPLICATIONS

- IoT Edge Devices
- Devices Powered by Coin/Button/Dry Batteries
- Alarms, Smartwatches etc.

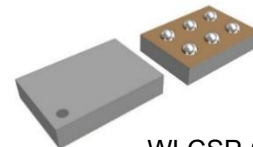
### GENERAL DESCRIPTION

The NC4650 is a synchronous rectification boost switching regulator featuring ultra-low quiescent current of 70nA, utilizing a CMOS process. It is optimal for portable devices powered by coin or button batteries.

With high efficiency under light load conditions, it is ideal for intermittent operation applications, ensuring long battery life.

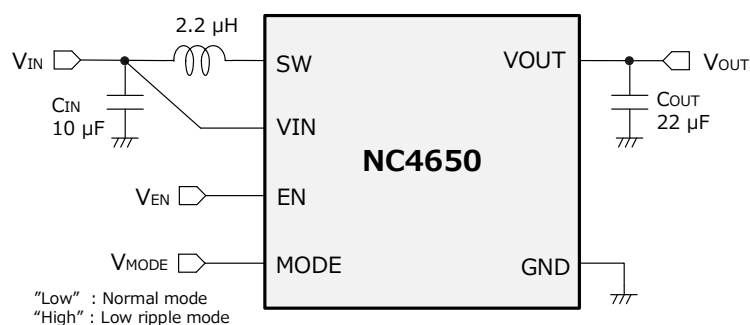
The MODE pin enables the selection of "Low Ripple Mode" for improved load transient response and reduced ripple. The EN pin allows shutdown operations, with options such as  $V_{IN}$ - $V_{OUT}$  Complete Disconnect,  $V_{OUT}$  discharge, and Pass-Through. Selecting the optimal version according to system sleep conditions enables system optimization.

### Package

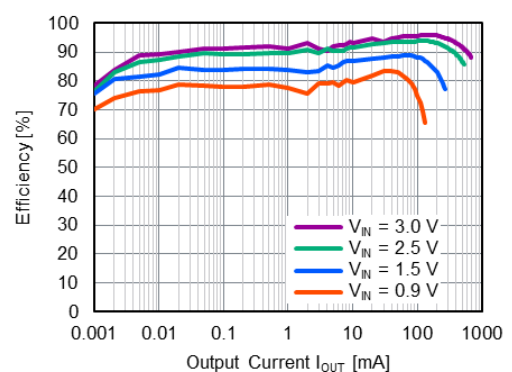


WLCSP-6-ZA1  
1.3 x 0.92 x 0.4 (mm)

### TYPICAL APPLICATION



### EFFICIENCY TYPICAL CHARACTERISTICS



NC4650ZA  $V_{OUT} = 3.3\text{ V}$  MODE = "Low"

## ■ PRODUCT NAME INFORMATION

| Product Name | Package     |
|--------------|-------------|
| NC4650ZA500D | WLCSP-6-ZA1 |

## Description of configuration

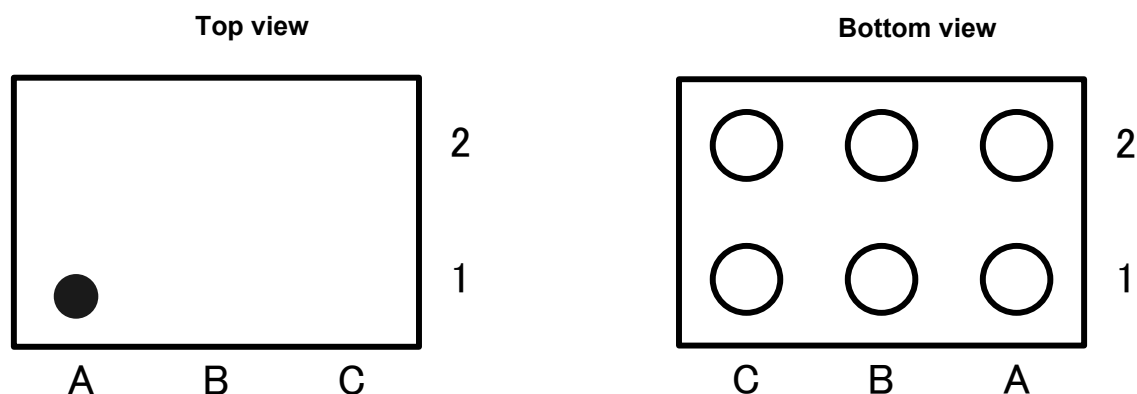
|     | Item           | Description                             |
|-----|----------------|-----------------------------------------|
| 500 | Output Voltage | Set Output Voltage ( $V_{SET}$ ): 5.0 V |

## Version

|   | EN Pin Function                           | Operation when Shutdown                                             |
|---|-------------------------------------------|---------------------------------------------------------------------|
| D | EN="High" : Shutdown<br>EN="Low" : Active | $V_{IN}$ - $V_{OUT}$ Pass-Through<br>Seamless Pass-Through Function |

- For more details on NC4650 IC, please refer to  
<https://www.nisshinbo-microdevices.co.jp/en/products/dc-dc-switching-regulator/spec/?product=nc4650>

## ■ PIN DESCRIPTION (NC4650ZA)



WLCSP-6-ZA1 Pin Configuration

NC4650ZA (WLCSP-6-ZA1) Pin Descriptions

| Pin No. | Pin Name | I/O   | Description                                                                                                             |
|---------|----------|-------|-------------------------------------------------------------------------------------------------------------------------|
| A1      | VOUT     | Power | Output Pin                                                                                                              |
| B1      | GND      | -     | Ground Pin                                                                                                              |
| C1      | VIN      | Power | Power Supply Pin                                                                                                        |
| A2      | SW       | -     | Switching Output Pin<br>Connect to Internal MOSFET Drain                                                                |
| B2      | MODE     | I     | Mode Control Pin<br>Low: Normal Mode, High: Low Ripple Mode                                                             |
| C2      | EN       | I     | Enable Pin<br>NC4650ZAxxxD: Can set the active state with the "Low" input and the shutdown state with the "High" input. |

## ■ ABSOLUTE MAXIMUM RATINGS

| Parameter                          | Symbol            | Ratings     | Unit |
|------------------------------------|-------------------|-------------|------|
| VIN pin Voltage                    | V <sub>IN</sub>   | -0.3 to 6.5 | V    |
| VOU <sub>T</sub> pin Voltage       | V <sub>OUT</sub>  | -0.3 to 6.5 | V    |
| SW pin Voltage                     | V <sub>SW</sub>   | -0.3 to 6.5 | V    |
| EN pin Voltage                     | V <sub>EN</sub>   | -0.3 to 6.5 | V    |
| MODE pin Voltage                   | V <sub>MODE</sub> | -0.3 to 6.5 | V    |
| Storage Temperature Range          | T <sub>stg</sub>  | -55 to 150  | °C   |
| Junction Temperature <sup>*1</sup> | T <sub>J</sub>    | -40 to 150  | °C   |

## ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause permanent damage and may degrade the lifetime and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

<sup>\*1</sup> Calculate the power consumption of the IC from the operating conditions, and calculate the junction temperature with the thermal resistance.

Please refer to "THERMAL CHARACTERISTICS" for the thermal resistance under our measurement board conditions

## ■ RECOMMENDED OPERATING CONDITIONS

|                             | Symbol          | Ratings    | unit |
|-----------------------------|-----------------|------------|------|
| VIN pin Voltage             | V <sub>IN</sub> | 0.6 to 5.5 | V    |
| Operating Temperature Range | T <sub>a</sub>  | -40 to 85  | °C   |
| Junction Temperature Range  | T <sub>J</sub>  | -40 to 125 | °C   |

## RECOMMENDED OPERATING CONDITIONS

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

## ■ ELECTRICAL CHARACTERISTICS

For parameter that do not describe the temperature condition, the MIN / MAX value under the condition of  $-40^{\circ}\text{C} \leq T_j \leq 125^{\circ}\text{C}$  is described.

| Parameter                              | Symbol               | Conditions                                                                                                                                                                                                              | MIN     | TYP                            | MAX     | Unit               |
|----------------------------------------|----------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|--------------------------------|---------|--------------------|
| Output Voltage                         | $V_{\text{OUTCM}}$   | PWM,<br>$V_{\text{SET}} \geq 2.5\text{V}$ , $T_j = 25^{\circ}\text{C}$                                                                                                                                                  | x 0.985 |                                | x 1.015 | V                  |
|                                        |                      | PWM,<br>$V_{\text{SET}} < 2.5\text{V}$ , $T_j = 25^{\circ}\text{C}$ ,                                                                                                                                                   | x 0.98  |                                | x 1.02  | V                  |
|                                        |                      | PWM,<br>$V_{\text{SET}} \geq 2.5\text{V}$ ,<br>$-40^{\circ}\text{C} \leq T_j \leq 85^{\circ}\text{C}$                                                                                                                   | x 0.975 |                                | x 1.025 | V                  |
|                                        |                      | PWM,<br>$V_{\text{SET}} < 2.5\text{V}$ ,<br>$-40^{\circ}\text{C} \leq T_j \leq 85^{\circ}\text{C}$                                                                                                                      | x 0.97  |                                | x 1.03  | V                  |
|                                        | $V_{\text{OUTDCM}}$  | PFM, $V_{\text{IN}} = 1.5\text{V}$                                                                                                                                                                                      |         | $V_{\text{OUTCM}} \times 1.02$ |         | V                  |
| Startup Voltage                        | $V_{\text{START}}$   | $-40^{\circ}\text{C} \leq T_j \leq 85^{\circ}\text{C}$                                                                                                                                                                  |         | 0.8                            | 0.9     | V                  |
| VIN UVLO                               | $V_{\text{VINUVLO}}$ | $V_{\text{IN}} = \text{falling}$ , $V_{\text{OUT}} = V_{\text{SET}}$                                                                                                                                                    |         | 0.4                            | 0.6     | V                  |
| VIN pin Quiescent Current              | $I_{\text{QVIN}}$    | $V_{\text{OUT}} = V_{\text{SET}}$ , $V_{\text{IN}} = 1.5\text{V}$ ,<br>$V_{\text{MODE}} = 0\text{V}$ , no switching,                                                                                                    |         | 0                              |         | nA                 |
| VOUT pin Quiescent Current             | $I_{\text{QVOUT}}$   | $V_{\text{OUT}} = V_{\text{SET}}$ , $V_{\text{IN}} = 1.5\text{V}$ ,<br>$V_{\text{MODE}} = 0\text{V}$ , no switching,<br>$-40^{\circ}\text{C} \leq T_j \leq 85^{\circ}\text{C}$                                          |         | 70                             | 300     | nA                 |
|                                        |                      | $V_{\text{OUT}} = V_{\text{SET}}$ , $V_{\text{IN}} = 1.5\text{V}$ ,<br>$V_{\text{MODE}} = V_{\text{IN}}$ , no switching,<br>$-40^{\circ}\text{C} \leq T_j \leq 85^{\circ}\text{C}$                                      |         | 90                             | 180     | $\mu\text{A}$      |
| VIN pin Shutdown Current*1             | $I_{\text{SDVIN}}$   | $V_{\text{IN}} = 5.5\text{V}$<br>$V_{\text{EN}} = 0\text{V}$ (A, B Version)<br>$V_{\text{EN}} = 5.5\text{V}$ (C, D Version)<br>$-40^{\circ}\text{C} \leq T_j \leq 85^{\circ}\text{C}$                                   |         | 50                             | 200     | nA                 |
| VOUT pin Shutdown Current*1            | $I_{\text{SDVOUT}}$  | $V_{\text{IN}} = 0\text{V}$ , $V_{\text{OUT}} = V_{\text{SET}}$<br>$V_{\text{EN}} = 0\text{V}$ (A Version)<br>$V_{\text{EN}} = V_{\text{SET}}$ (C, D Version)<br>$-40^{\circ}\text{C} \leq T_j \leq 85^{\circ}\text{C}$ |         | 40                             | 250     | nA                 |
| EN pin "H" Input Current               | $I_{\text{ENH}}$     | $V_{\text{IN}} = V_{\text{EN}} = 5.5\text{V}$<br>$-40^{\circ}\text{C} \leq T_j \leq 85^{\circ}\text{C}$                                                                                                                 | -40     | 0                              | 40      | nA                 |
| EN pin "L" Input Current               | $I_{\text{ENL}}$     | $V_{\text{IN}} = 5.5\text{V}$ , $V_{\text{EN}} = 0\text{V}$<br>$-40^{\circ}\text{C} \leq T_j \leq 85^{\circ}\text{C}$                                                                                                   | -40     | 0                              | 40      | nA                 |
| MODE pin "H" Input Current             | $I_{\text{MODEH}}$   | $V_{\text{IN}} = V_{\text{MODE}} = 5.5\text{V}$<br>$-40^{\circ}\text{C} \leq T_j \leq 85^{\circ}\text{C}$                                                                                                               | -40     | 0                              | 40      | nA                 |
| MODE pin "L" Input Current             | $I_{\text{MODEL}}$   | $V_{\text{IN}} = 5.5\text{V}$ , $V_{\text{MODE}} = 0\text{V}$<br>$-40^{\circ}\text{C} \leq T_j \leq 85^{\circ}\text{C}$                                                                                                 | -40     | 0                              | 40      | nA                 |
| EN pin "H" Input Voltage *2            | $V_{\text{ENH}}$     |                                                                                                                                                                                                                         | 0.9     |                                | 5.5     | V                  |
| EN pin "L" Input Voltage *2            | $V_{\text{ENL}}$     |                                                                                                                                                                                                                         | 0       |                                | 0.3     | V                  |
| MODE pin "H" Input Voltage *2          | $V_{\text{MODEH}}$   |                                                                                                                                                                                                                         | 1.0     |                                | 5.5     | V                  |
| MODE pin "L" Input Voltage *2          | $V_{\text{MODEL}}$   |                                                                                                                                                                                                                         | 0       |                                | 0.3     | V                  |
| SW pin "H" Input Current               | $I_{\text{SWH}}$     | $V_{\text{IN}} = V_{\text{SW}} = 5\text{V}$ , $V_{\text{OUT}} = 0\text{V}$<br>$-40^{\circ}\text{C} \leq T_j \leq 85^{\circ}\text{C}$                                                                                    |         | 1                              | 350     | nA                 |
| SW pin "L" Input Current               | $I_{\text{SWL}}$     | $V_{\text{IN}} = V_{\text{SW}} = 0\text{V}$ , $V_{\text{OUT}} = 5\text{V}$<br>$-40^{\circ}\text{C} \leq T_j \leq 85^{\circ}\text{C}$                                                                                    | -200    | -1                             |         | nA                 |
| On-resistance of High Side MOSFET      | $R_{\text{ONH}}$     | $V_{\text{OUT}} = 3.3\text{V}$                                                                                                                                                                                          |         | 0.28                           |         | $\Omega$           |
| On-resistance of Low Side MOSFET       | $R_{\text{ONL}}$     | $V_{\text{OUT}} = 3.3\text{V}$                                                                                                                                                                                          |         | 0.22                           |         | $\Omega$           |
| Thermal Shutdown Detection Temperature | $T_{\text{SDDET}}$   |                                                                                                                                                                                                                         |         | 150                            |         | $^{\circ}\text{C}$ |
| Thermal Shutdown Release Temperature   | $T_{\text{SDREL}}$   |                                                                                                                                                                                                                         |         | 100                            |         | $^{\circ}\text{C}$ |
| Inductor Ripple Current                | $I_{\text{RIP}}$     | $V_{\text{IN}} = 1.5\text{V}$ , $V_{\text{OUT}} = V_{\text{SET}}$                                                                                                                                                       |         | 250                            |         | mA                 |

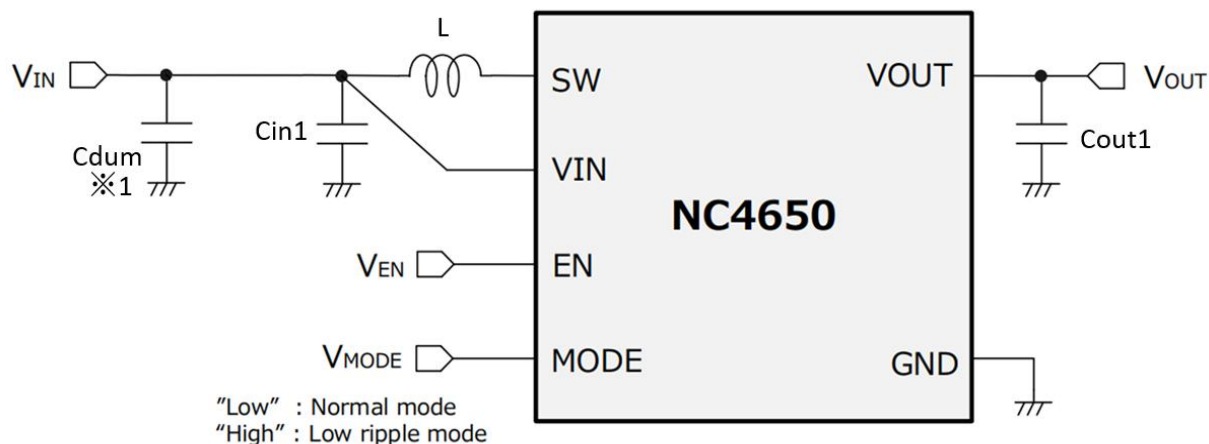
| Parameter                           | Symbol | Conditions                                                                                                     | MIN | TYP                     | MAX  | Unit     |
|-------------------------------------|--------|----------------------------------------------------------------------------------------------------------------|-----|-------------------------|------|----------|
| SW Current Limit                    | ISWLIM | $V_{SET} \geq 2.5V, V_{IN} = 1.5V$                                                                             | 700 | 1000                    | 1500 | mA       |
|                                     |        | $V_{SET} < 2.5V, V_{IN} = 1.5V$                                                                                | 450 | 650                     | 950  | mA       |
| On-resistance for Discharger        | RONDIS | $V_{IN} = 1.5V$ , B Version only                                                                               |     | 55                      |      | $\Omega$ |
| Soft-Start Time                     | tSTART |                                                                                                                |     | 0.8                     | 1.5  | ms       |
| Pass-Through Mode Detection Voltage | VPTHD  | $V_{IN} - V_{OUT}$                                                                                             |     | 0.6                     | 0.8  | V        |
| Pass-Through Mode Release Voltage   | VPTHR  | $V_{OUT}$                                                                                                      |     | $V_{OUTCM} \times 1.02$ |      | V        |
| Pass-Through Mode Quiescent Current | IQPTML | $V_{MODE} = 0V$ ,<br>$V_{IN} = V_{SET} + 0.4V$                                                                 |     | 70                      |      | nA       |
|                                     | IQPTMH | $V_{MODE} = V_{IN}$ ,<br>$V_{IN} = V_{SET} + 0.4V$                                                             |     | 90                      |      | $\mu A$  |
| Buck Mode Detection Voltage         | VBKDML | $V_{IN} = \text{Rising or } V_{OUT} = \text{Falling}$<br>$V_{BKDML} = V_{IN} - V_{OUT}$<br>$V_{MODE} = 0V$     |     | -0.05                   |      | V        |
|                                     | VBKDMH | $V_{IN} = \text{Rising or } V_{OUT} = \text{Falling}$<br>$V_{BKDMH} = V_{IN} - V_{OUT}$<br>$V_{MODE} = V_{IN}$ |     | -0.1                    |      | V        |
| Buck Mode Release Voltage           | VBKRL  | $V_{IN} = \text{Falling or } V_{OUT} = \text{Rising}$<br>$V_{BKRL} = V_{IN} - V_{OUT}$<br>$V_{MODE} = 0V$      |     | -0.1                    |      | V        |
|                                     | VBKRMH | $V_{IN} = \text{Falling or } V_{OUT} = \text{Rising}$<br>$V_{BKRMH} = V_{IN} - V_{OUT}$<br>$V_{MODE} = V_{IN}$ |     | -0.2                    |      | V        |

All electrical characteristic parameters that specify the minimum and maximum specifications are tested under the condition of  $T_j \approx T_a = 25^\circ C$ .

\*1 On the VIN and VOUT pins, the shutdown current flows only from the pin with the higher voltage. The pin with the lower voltage is Typ. 0 nA.

\*2 When the EN and MODE pins are fixed to the VIN pin, the polarity is forced to be "H" as long as VIN pin voltage within the recommended operating condition. (The A and B version)

## Typical Application Circuit



※1 Testing with this EV board, an external attachment might be necessary for evaluation of the correct performance of the NC4650 and already has been attached as C<sub>dum</sub>.

For evaluation, wiring for power supply or GND will be used. Considering the voltage drop or noise by the wiring, C<sub>dum</sub> has been mounted on the EV board to obtain the right performance of the NC4650 in the actual PCB layout or measurement unit's wire is very short, and C<sub>dum</sub> will be unnecessary.

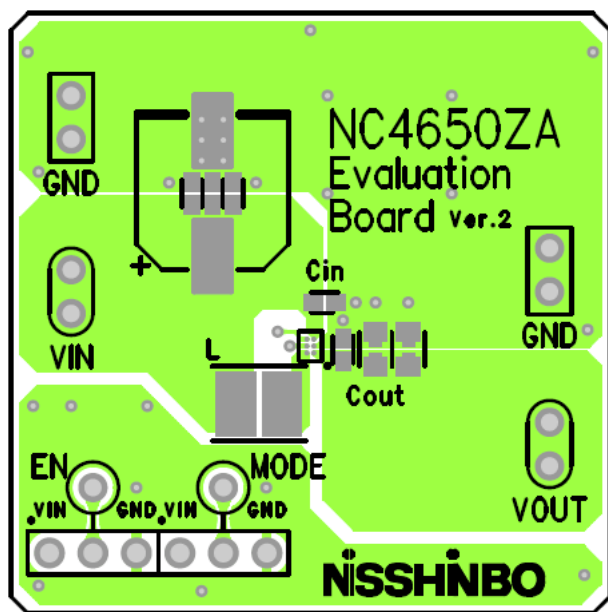
## Recommended values for components

| Symbol                | Capacitance  |
|-----------------------|--------------|
| C <sub>in1</sub>      | 10 $\mu$ F   |
| C <sub>out1</sub>     | 22 $\mu$ F   |
| L                     | 2.2 $\mu$ H  |
| C <sub>dum</sub> (※1) | 10 $\mu$ F*3 |

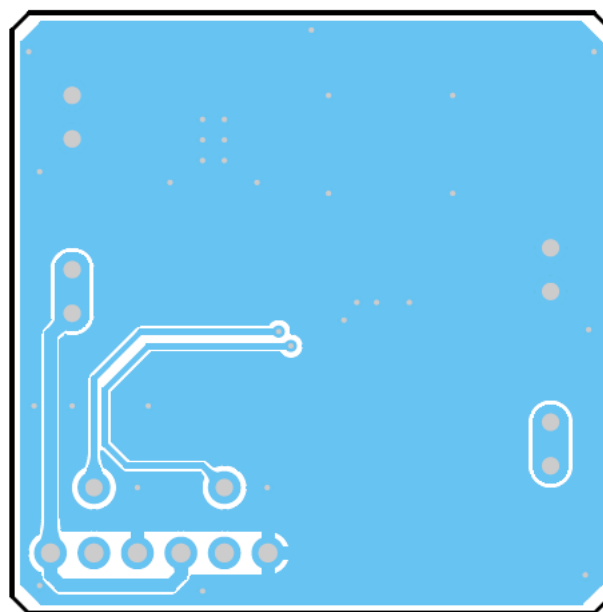
The bill of materials will be attached on the shipment of each purchased evaluation board.

## ■ Evaluation Board / PCB Layout Pattern Example

NC4650ZA (WLCSP-6-ZA1)



Top Layer



Bottom Layer

When designing PCB layout patterns, pay close attention to the following items.

- External components should be placed as close as possible to the IC and on the same side, and the wiring from the IC to the components should be short. In particular, the capacitor  $C_{IN}$  connected between  $V_{IN}$  and GND and the capacitor  $C_{OUT}$  connected between  $V_{OUT}$  and GND should be placed at the shortest possible distance from the terminals.
- Current due to switching flows through the power supply wiring, ground wiring and SW pins. If the impedance of the power and ground wiring is high, the potential inside the IC may fluctuate due to the switching current, causing the IC to operate unstable. Therefore, the power and ground wiring should be short and thick.
- The wiring from the SW pin to the inductor is a noise source, so ensure that the current capacity is sufficient to prevent the noise from increasing and that the wiring is not thicker and longer than necessary.



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10. There can be variation in the marking when different AOI (Automated Optical Inspection) equipment is used. In the case of recognizing the marking characteristic with AOI, please contact our sales or our distributor before attempting to use AOI.
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